



#### **DUAL 40V N-CHANNEL ENHANCEMENT MODE MOSFET** PowerDI3333-8

# **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C		
40V	$10.8$ m $\Omega$ @ V <sub>GS</sub> = $10$ V	30.2A		
	$15m\Omega @ V_{GS} = 4.5V$	25.6A		

## **Description and Applications**

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Motor Control
- **Power Management Functions**
- **DC-DC Converters**

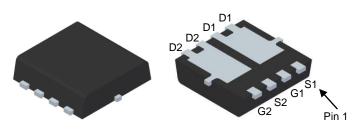
#### **Features**

- 100% Unclamped Inductive Switching, Test in Production -Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R<sub>DS(ON)</sub> Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- **PPAP Capable (Note 4)**

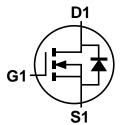
#### **Mechanical Data**

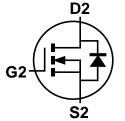
- Case: PowerDI®3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.072 grams (Approximate)

#### PowerDI3333-8 (Type UXC)









**Equivalent Circuit** 

### Ordering Information (Note 5)

Part Number	Case	Packaging
DMT47M2LDVQ-7	PowerDI3333-8 (Type UXC)	2000/Tape & Reel
DMT47M2LDVQ-13	PowerDI3333-8 (Type UXC)	3000/Tape & Reel

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

### **Marking Information**



M2D = Product Type Marking Code YYWW = Date Code Marking  $\overline{YY}$  = Last Two Digits of Year (ex: 19 for 2019) WW = Week Code (01 to 53)

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# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V <sub>DSS</sub>	40	V	
Gate-Source Voltage	V <sub>GSS</sub>	±20	V	
Continuous Drain Current (Note 7), V <sub>GS</sub> = 10V	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	I <sub>D</sub>	30.2 24.2	А
Continuous Drain Current (Note 6), $V_{GS} = 10V$ $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		I <sub>D</sub>	11.9 9.5	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	120	Α	
Maximum Continuous Body Diode Forward Current (Note 7)	Is	16.4	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle =	I <sub>SM</sub>	120	Α	
Avalanche Current, L = 0.1mH (Note 8)	I <sub>AS</sub>	22.1	Α	
Avalanche Energy, L = 0.1mH (Note 8)	E <sub>AS</sub>	24.4	mJ	

### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)	$T_A = +25$ °C	$P_{D}$	2.34	W
Thermal Resistance, Junction to Ambient (Note 6)		$R_{ hetaJA}$	53.7	°C/W
Total Power Dissipation (Note 7)	$P_{D}$	14.8	W	
Thermal Resistance, Junction to Case (Note 7)		$R_{ heta JC}$	8.43	°C/W
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +150	°C

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	40	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 32V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	$V_{GS(TH)}$	1.2	1.4	2.3	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	_		8.4	10.8	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	10.9	15	11177	$V_{GS} = 4.5V, I_D = 10A$	
Diode Forward Voltage	V <sub>SD</sub>	_	0.9	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A	
DYNAMIC CHARACTERISTICS (Note 10)			•	•			
Input Capacitance	C <sub>iss</sub>		891	_		$V_{DS}$ = 20V, $V_{GS}$ = 0V, $f$ = 1MHz	
Output Capacitance	Coss	_	490	_	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>		14.8	_			
Gate Resistance	Rg	_	1.87	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 10V)	$Q_g$	_	14.0	_		V <sub>DS</sub> = 20V, I <sub>D</sub> = 20A	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	6.72	_	nC		
Gate-Source Charge	Q <sub>qs</sub>	_	1.04	_	nc		
Gate-Drain Charge	$Q_{qd}$	_	2.52	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.95	_		$V_{DD} = 20V, V_{GS} = 10V,$ $R_G = 3\Omega, I_D = 20A$	
Turn-On Rise Time	t <sub>R</sub>	_	5.41	_			
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	15.4	_	ns		
Turn-Off Fall Time	t <sub>F</sub>		8.53	_			
Body Diode Reverse Recovery Time	t <sub>RR</sub>		56.6	_	ns	1 00A di/dt 400A/vs	
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>		40.0	_	$_{\rm nC}$ $I_{\rm F} = 20$ A, di/dt = 100A/µs		

6. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
7. Thermal resistance from junction to soldering point (on the exposed drain pad). Notes:

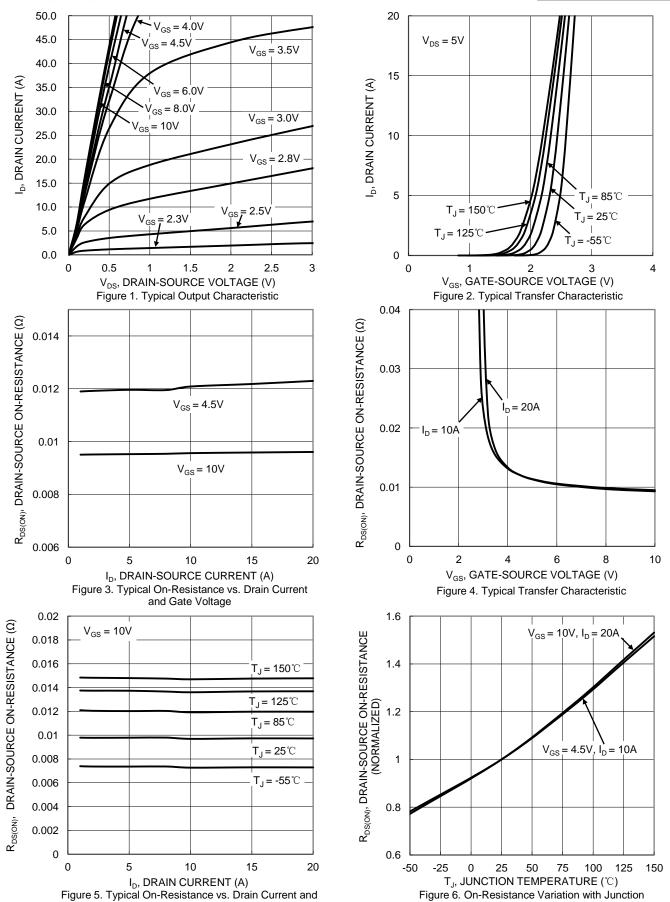
<sup>8.</sup>  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J = +25$ °C.

<sup>9.</sup> Short duration pulse test used to minimize self-heating effect.

<sup>10.</sup> Guaranteed by design. Not subject to product testing.





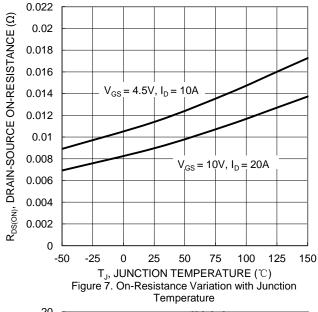


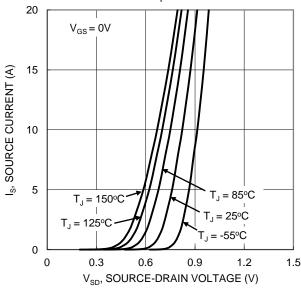
Junction Temperature

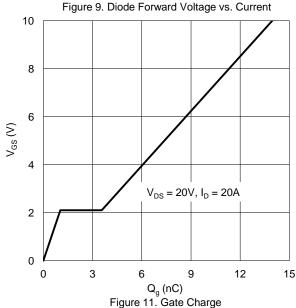
Temperature

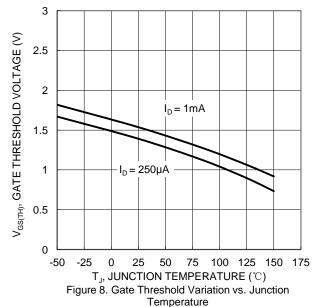


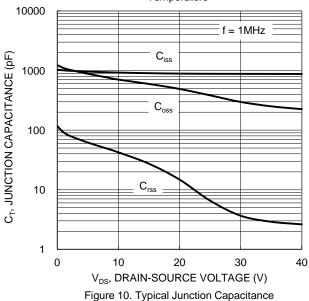


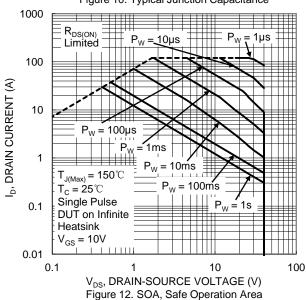














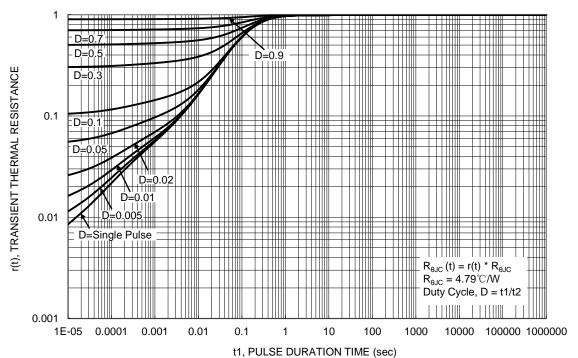


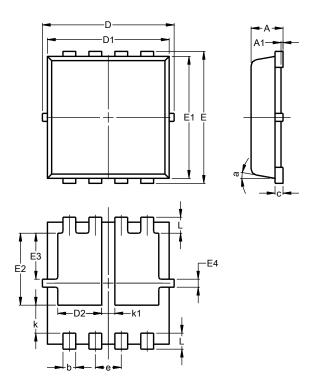
Figure 13. Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI3333-8 (Type UXC)

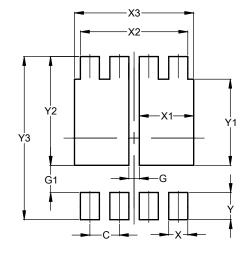


PowerDI3333-8						
(Type UXC)						
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
<b>A</b> 1	0.00	0.05				
b	0.25	0.40	0.32			
С	0.10	0.25	0.15			
D	3.20	3.40	3.30			
D1	2.95	3.15	3.05			
D2	0.90	1.30	1.10			
Е	3.20	3.40	3.30			
E1	2.95	3.15	3.05			
E2	1.60	2.00	1.80			
E3	0.95	1.35	1.15			
E4	0.10	0.30	0.20			
е	-	-	0.65			
L	0.30	0.50	0.40			
k	0.50	0.90	0.70			
k1	0.13	0.53	0.33			
а	0°	12°	10°			
All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI3333-8 (Type UXC)



Dimensions	Value (in mm)			
С	0.650			
G	0.230			
G1	0.600			
Х	0.420			
X1	1.200			
X2	2.370			
Х3	2.630			
Y	0.600			
Y1	1.900			
Y2	2.400			
Y3	3.600			



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